



Integrated Device Technology, Inc.
2975 Stender Way, Santa Clara, CA - 95054

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: G-0206-09	DATE: 6/17/2002	MEANS OF DISTINGUISHING CHANGED DEVICES: ☐ Product Mark ☐ Back Mark ☐ Date Code ☒ Other Starting ww40
Product Affected: MQFP, PQFP and TQFP packages in Tape and Reel		
Date Effective: 9/30/2002		

Contact: Geoffrey Cortes		
Title: Manager, Corporate Quality & Reliability	Attachment: ☐ Yes ☒ No	
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E-mail: Geoffrey.Cortes@idt.com		

DESCRIPTION AND PURPOSE OF CHANGE:

☐ Die Technology	
☐ Wafer Fabrication Process	
☐ Assembly Process	
☐ Equipment	
☒ Material	IDT currently ships products in 20x20 mm & 28x28 mm packages using Tape and Reel, if the ordering part # ends with "8". Effective 09/30/02, IDT will not offer these package types in Tape and Reel. Product will be shipped in Trays only.
☐ Testing	
☐ Manufacturing Site	
☐ Data Sheet	
☐ Other	This PCN effects product shipped in Tape and Reel only.

RELIABILITY/QUALIFICATION SUMMARY:

Not applicable. Shipping material change only.

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.

IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____	☐ Approval for shipments prior to effective date.
Name/Date: _____	E-Mail Address: _____
Title: _____	Phone# /Fax# : _____

CUSTOMER COMMENTS: _____

IDT ACKNOWLEDGMENT OF RECEIPT:	
RECD. BY: _____	DATE: _____